



# FE2.1

## USB 2.0 HIGH SPEED 7-PORT HUB CONTROLLER

### Data Sheet

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#### INTRODUCTION

The FE2.1 is a highly integrated, high quality, high performance, low power consumption, yet low overall cost solution for USB 2.0 High Speed 7-Port Hub.

It adopts *Multiple Transaction Translator* (MTT) architecture to explore the maximum possible throughput. Six, instead of two, non-periodic transaction buffers are used to minimize potential traffic jamming. The whole design is based on state-machine-control to reduce the response delay time; no micro controller is used in this chip.

To guarantee high quality, the whole chip is covered by *Test Scan Chain* – include even the high speed (480MHz) modules, so that all the logic components could be fully tested before shipping. Special *Build-In-Self-Test* mode is designed to exercise all high, full, and low speed Analog Front End (AFE) components in the packaging and testing stages as well.

Low power consumption is achieved by using 0.18  $\mu$  m technology and comprehensive power/clock control mechanism. Most part of the chip will not be clocked unless needed.

#### FEATURES

- Low power consumption
  - 155 mA when seven downstream facing ports enabled in High-Speed mode;
  - 66 mA when one downstream facing port enabled in High-Speed mode;
- Fully compliant with Universal Serial Bus Specification Revision 2.0 (USB 2.0);
  - Upstream facing port supports High-Speed (480MHz) and Full-Speed (12MHz) modes;
  - 7 downstream facing ports support High-Speed (480MHz), Full-Speed (12MHz), and Low-Speed (1.5MHz) modes;
- Integrated USB 2.0 Transceivers;
- Integrated upstream 1.5K $\Omega$  pull-up, downstream 15K $\Omega$  pull-down, and serial resistors;
- Integrated 5V to 3.3V and 1.8V regulator.
- Integrated Power-On-Reset circuit;
- Integrated 12MHz Oscillator with feedback resistor and crystal load capacitor;
- Integrated 12MHz-to-480MHz Phase Lock Loop (PLL);
- *Multiple Transaction Translator* (MTT) –
  - One TT for each downstream port;



- ☐ Alternate Interface 0 for Single-TT, and Alternate Interface 1 for Multiple-TT;
- ☐ Each TT could handle 64 periodic Start-Split transactions, 32 periodic Complete-Split transactions, and 6 none-periodic transactions;
- Support Self-Powered Mode only;
- Board configured options –
  - ☐ *Ganged or Individual Power Control Mode* select;
  - ☐ *Global, Multiple Ganges, or Individual Over-Current Protection Mode* select;
  - ☐ *Removable or Non-Removable Downstream Devices* configuration;
  - ☐ *Number of Downstream Ports*;
- EEPROM configured options –
  - ☐ *Vendor ID, Product ID, & Device Release Number*;
  - ☐ *Removable or Non-Removable Downstream Devices* configuration;
  - ☐ *Serial Number*; and
  - ☐ *Number of Downstream Ports*;
- Comprehensive status indicators support:
  - ☐ Standard downstream port status indicators (Green and Amber LED control for each downstream port);
  - ☐ *Hub Active/Suspend* indicator LED.

## BLOCK DIAGRAM

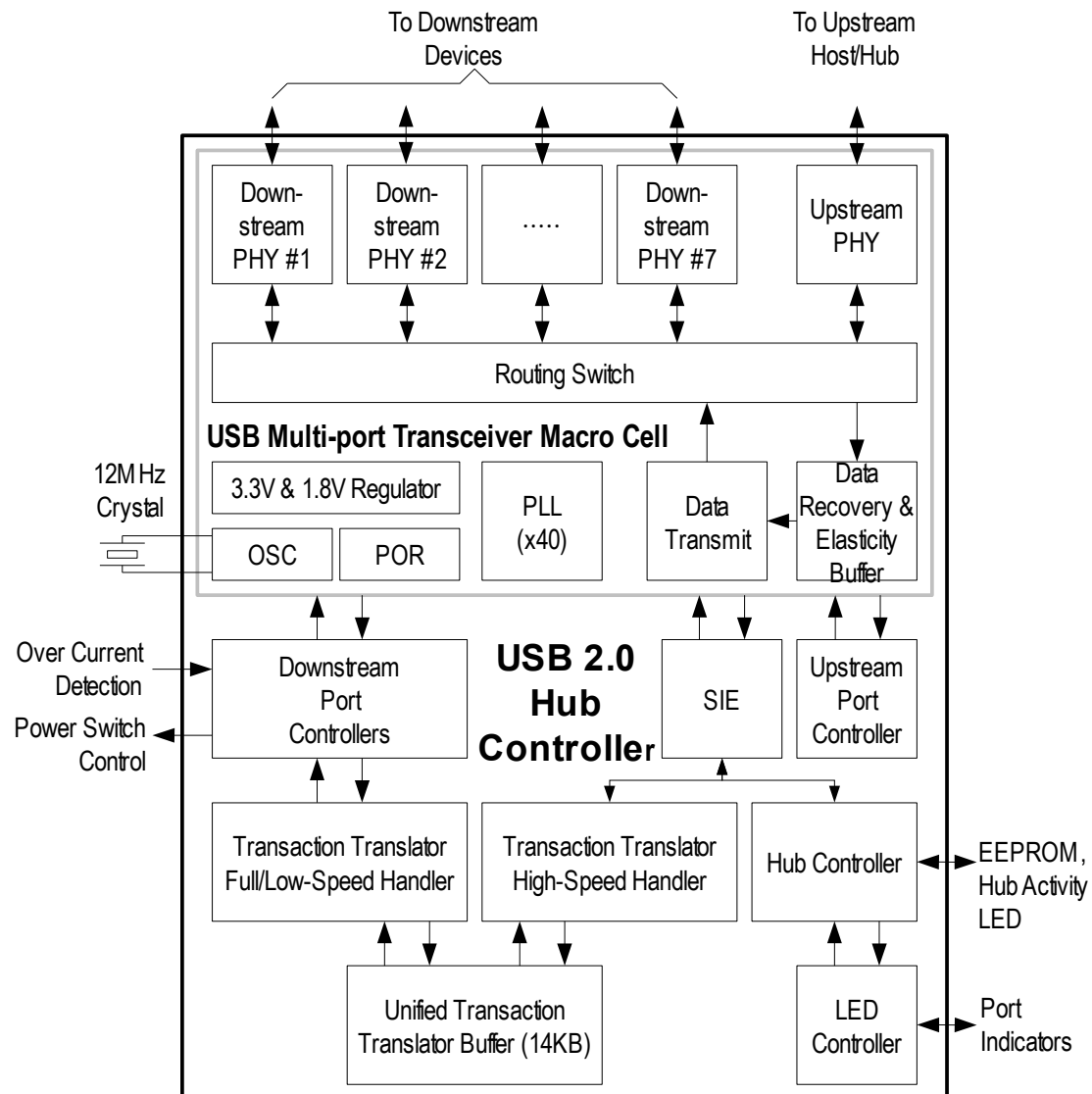


Fig. 1: Block Diagram



**PACKAGE I – 64-PIN LQFP**  
(Body Size: 10x10 mm)

**PIN ASSIGNMENT**

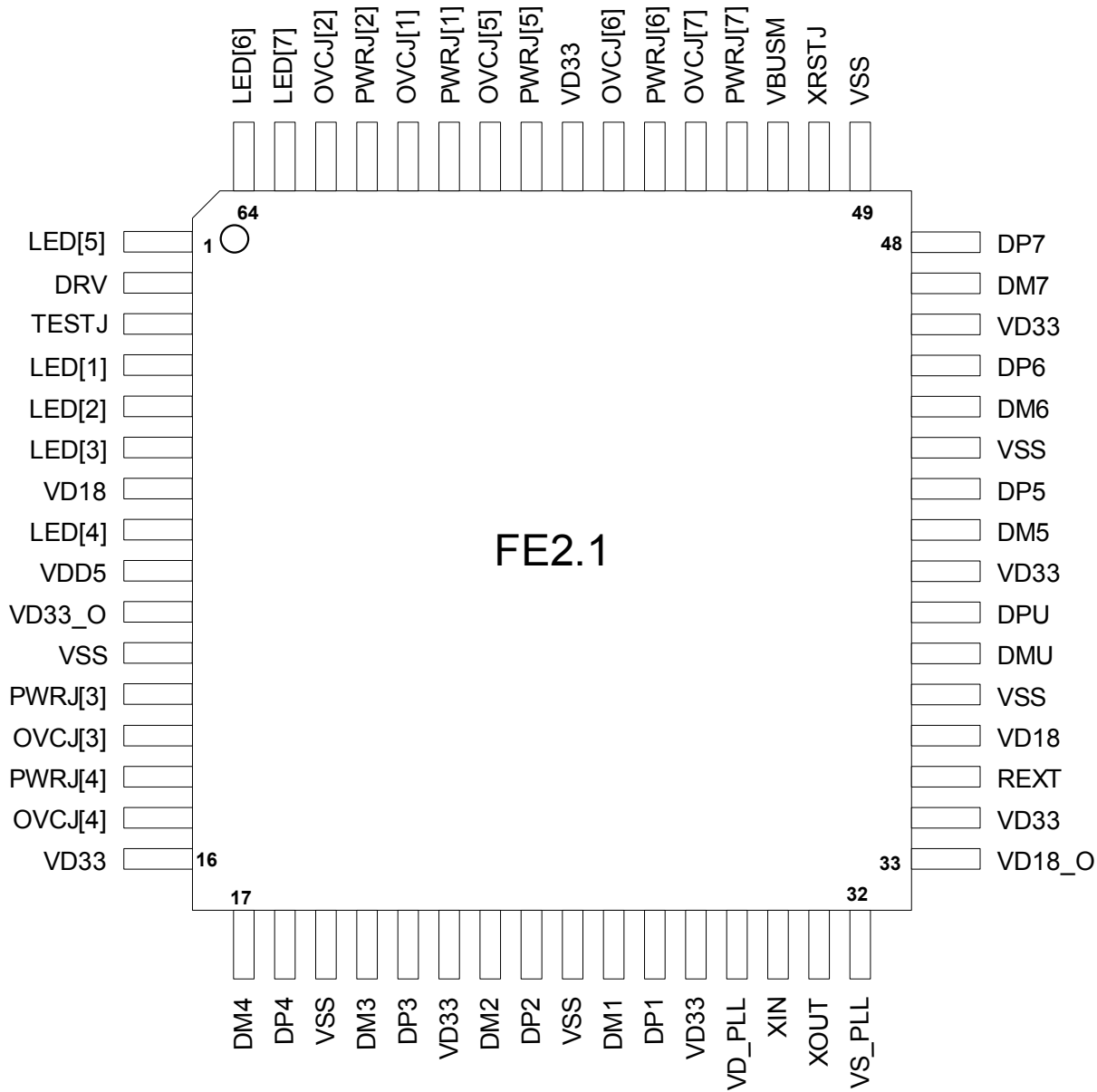
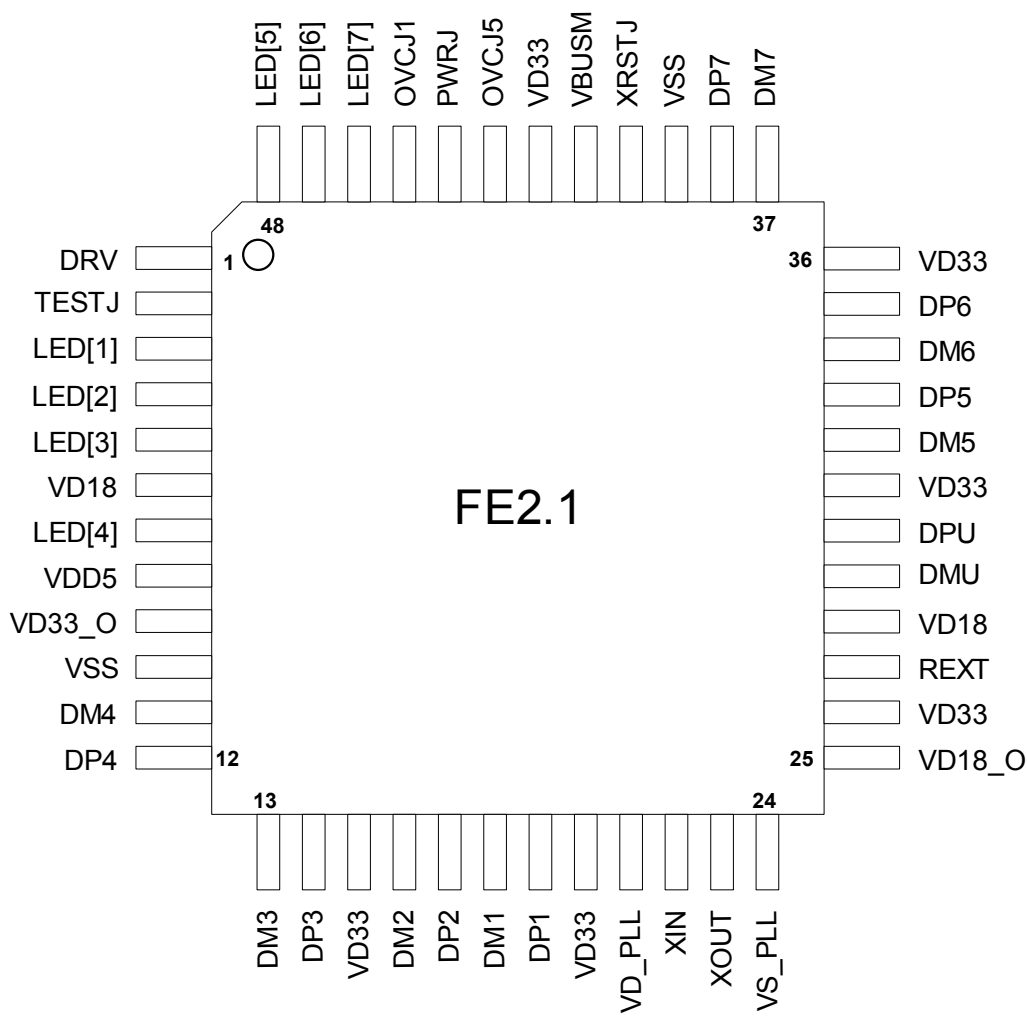


Fig. 2: 64-pin LQFP Pin Assignment



**PACKAGE II – 48-PIN LQFP**  
(Body Size: 7x7 mm)

**PIN ASSIGNMENT**



*Fig. 3: 48-pin LQFP Pin Assignment*



## PIN DESCRIPTION TABLE

| Pin Name | 64-pin<br>LQFP<br>Pin#              | 48-pin<br>LQFP<br>Pin#       | Type        | Function  | Note |
|----------|-------------------------------------|------------------------------|-------------|---|------|
| LED[5]   | 1                                   | 48                           | O           | LED Control for the 5 <sup>th</sup> Downstream Facing Port Status.  |      |
| DRV      | 2                                   | 1                            | O           | Driving Control for all LED.  |      |
| TESTJ    | 3                                   | 2                            | IO-PU       | Test Mode Enable during hardware reset, active low.<br>Otherwise, SDA, Serial Data/Address pin for external Serial EEPROM.  |      |
| LED[1]   | 4                                   | 3                            | O/<br>IO-PU | LED Control for the 1 <sup>st</sup> Downstream Facing Port Status, and<br>SCL, Serial Clock pin for external Serial EEPROM. | 4    |
| LED[2]   | 5                                   | 4                            | O/<br>I-PU  | LED Control for the 2 <sup>nd</sup> Downstream Facing Port Status, and<br>Non-Removable Device Configuration bit 0.         | 3    |
| LED[3]   | 6                                   | 5                            | O/<br>I-PU  | LED Control for the 3 <sup>rd</sup> Downstream Facing Port Status, and<br>Non-Removable Device Configuration bit 1.         | 3    |
| VD18     | 7, 36                               | 6, 28                        | P           | 1.8V power input.   |      |
| LED[4]   | 8                                   | 7                            | O/<br>I-PU  | LED Control for the 4 <sup>th</sup> Downstream Facing Port Status, and<br>Non-Removable Device Configuration bit 2.         | 3    |
| VDD5     | 9                                   | 8                            | P           | 5V power input for integrated 5V→3.3V regulator.  |      |
| VD33_O   | 10                                  | 9                            | P           | 3.3V power output from 5V→3.3V integrated regulator – a<br>10μF decoupling capacitor is required.                           |      |
| VSS      | 11, 19,<br>25, 37,<br>43, 49        | 10, 39                       | P           | Ground.   |      |
| PWRJ[3]  | 12                                  | —                            | OD          | Power Enable for 3 <sup>rd</sup> Downstream Facing Port, active low.  |      |
| OVCJ[3]  | 13                                  | —                            | I-PU        | Over-current Detect for 3 <sup>rd</sup> Downstream Facing Port, active low.   | 1    |
| PWRJ[4]  | 14                                  | —                            | OD          | Power Enable for 4 <sup>th</sup> Downstream Facing Port, active low.  |      |
| OVCJ[4]  | 15                                  | —                            | I-PU        | Over-current Detect for 4 <sup>th</sup> Downstream Facing Port, active low.   | 1    |
| VD33     | 16, 22,<br>28, 34,<br>40, 46,<br>56 | 15, 20,<br>26, 31,<br>36, 42 | P           | 3.3V Power Input.   |      |
| DM4      | 17                                  | 11                           | UTD         | The D- pin of the 4 <sup>th</sup> Downstream Facing Port.   |      |
| DP4      | 18                                  | 12                           | UTD         | The D+ pin of the 4 <sup>th</sup> Downstream Facing Port.   |      |



|         |    |    |             |  |      |
|---------|----|----|-------------|--|------|
| DM3     | 20 | 13 | UTD         | The D- pin of the 3 <sup>rd</sup> Downstream Facing Port.  |      |
| DP3     | 21 | 14 | UTD         | The D+ pin of the 3 <sup>rd</sup> Downstream Facing Port.  |      |
| DM2     | 23 | 16 | UTD         | The D- pin of the 2 <sup>nd</sup> Downstream Facing Port.  |      |
| DP2     | 24 | 17 | UTD         | The D+ pin of the 2 <sup>nd</sup> Downstream Facing Port.  |      |
| DM1     | 26 | 18 | UTD         | The D- pin of the 1 <sup>st</sup> Downstream Facing Port.  |      |
| DP1     | 27 | 19 | UTD         | The D+ pin of the 1 <sup>st</sup> Downstream Facing Port.  |      |
| VD_PLL  | 29 | 21 | P           | 1.8V Power for PLL.  |      |
| XIN     | 30 | 22 | OSC         | 12 MHz Crystal Oscillator input  |      |
| XOUT    | 31 | 23 | OSC         | 12 MHz Crystal Oscillator output.  |      |
| VS_PLL  | 32 | 24 | P           | Ground for PLL.  |      |
| VD18_O  | 33 | 25 | P           | 1.8V power output from 3.3V→1.8V integrated regulator – a 10μF decoupling capacitor is required.                 |      |
| REXT    | 35 | 27 | A           | A 2.7KΩ (± 1%) resistor should be connected to VSS to provide internal bias reference.                           |      |
| DMU     | 38 | 29 | UTU         | The D- pin of the Upstream Facing Port.  |      |
| DPU     | 39 | 30 | UTU         | The D+ pin of the Upstream Facing Port.  |      |
| DM5     | 41 | 32 | UTD         | The D- pin of the 5 <sup>th</sup> Downstream Facing Port.  |      |
| DP5     | 42 | 33 | UTD         | The D+ pin of the 5 <sup>th</sup> Downstream Facing Port.  |      |
| DM6     | 44 | 34 | UTD         | The D- pin of the 6 <sup>th</sup> Downstream Facing Port.  |      |
| DP6     | 45 | 35 | UTD         | The D+ pin of the 6 <sup>th</sup> Downstream Facing Port.  |      |
| DM7     | 47 | 37 | UTD         | The D- pin of the 7 <sup>th</sup> Downstream Facing Port.  |      |
| DP7     | 48 | 38 | UTD         | The D+ pin of the 7 <sup>th</sup> Downstream Facing Port.  |      |
| XRSTJ   | 50 | 40 | I           | External Reset, active low, is an optional source of chip reset signal. The minimum low pulse width is 10 μs.    |      |
| VBUSM   | 51 | 41 | I           | The V <sub>BUS</sub> Monitor of upstream facing port.  |      |
| PWRJ[7] | 52 | —  | OD/<br>I-PU | Power Enable for 7 <sup>th</sup> Downstream Facing Port, active low, and Power Control Mode Configuration bit 1. | 2    |
| OVCJ[7] | 53 | —  | I-PU        | Over-current Detect for 7 <sup>th</sup> Downstream Facing Port, active low.                                      | 1    |
| PWRJ[6] | 54 | —  | OD/<br>I-PU | Power Enable for 6 <sup>th</sup> Downstream Facing Port, active low, and Power Control Mode Configuration bit 1. | 2    |
| OVCJ[6] | 55 | —  | I-PU        | Over-current Detect for 6 <sup>th</sup> Downstream Facing Port, active low.                                      | 1    |
| PWRJ[5] | 57 | —  | OD          | Power Enable for 5 <sup>th</sup> Downstream Facing Port, active low.   |      |
| OVCJ[5] | 58 | 43 | I-PU        | Over-current Detect for 5 <sup>th</sup> Downstream Facing Port, active low.                                      | 1    |
| PWRJ[1] | 59 | 44 | OD          | Power Enable for 1 <sup>st</sup> Downstream Facing Port, active low.   |      |
| OVCJ[1] | 60 | 45 | I           | Over-current Detect for 1 <sup>st</sup> Downstream Facing Port, active low.                                      | 1, 3 |
| PWRJ[2] | 61 | —  | OD          | Power Enable for 2 <sup>nd</sup> Downstream Facing Port, active low.   |      |



|         |    |    |            |  |   |
|---------|----|----|------------|--|---|
| OVCJ[2] | 62 | —  | I-PU       | Over-current Detect for 2 <sup>nd</sup> Downstream Facing Port, active low.                                    | 1 |
| LED[7]  | 63 | 46 | O/<br>I-PU | LED Control for the 7 <sup>th</sup> Downstream Facing Port Status, and<br>Number of Ports Configuration bit 0. | 3 |
| LED[6]  | 64 | 47 | O/<br>I-PU | LED Control for the 6 <sup>th</sup> Downstream Facing Port Status, and<br>Number of Ports Configuration bit 1. | 3 |

### Note

1. Pins OVCJ[7:2] are equipped with optional internal pull-up resistors. When certain OVCJ pin is not required by currently configured over-current protection mode, its internal pull-up resistor will be applied so that pin can be left as unconnected on the board. Otherwise, when certain OVCJ pin is used by currently configured over-current protection mode, its pull-up resistor will be removed so that it could be used to monitor either 3.3V or 5V input from external application circuit.
2. During power up configuration stage, pins PWRJ[7:6] are used as input with internal pull-up resistors. Once passed that stage, they will be configured as open drain output.
3. During power up configuration stage, pins LED[4:2] and LED[7:6] are used as input with internal pull-up resistor. Once passed that stage, they will be configured as CMOS output.
4. During power up configuration stage, pin LED[1] is used as CMOS tristate I/O to work with the external EEPROM as serial clock. Once passed that stage, it is used as CMOS output.

### Type Abbreviation –

I : Schmitt Trigger Input, 5V-Tolerant;  
 I-PU : Input with Controllable Internal Pull-Up, 5V-Tolerant when pull-up resistors is disabled;  
 IO-PU : CMOS 3-state Output with Input and Internal Pull-Up;  
 OD : Open Drain Output;  
 O : CMOS Output;  
 A : Analog I/O;  
 P : Power/Ground;  
 OSC : Crystal Oscillator with internal bias resistor and load capacitor;  
 UTU : USB High Speed and Full Speed Transceiver;  
 UTD : USB High Speed, Full Speed, and Low Speed Transceiver.



## CONFIGURABLE OPTIONS

The FE2.1 is a highly versatile design that can be configured to meet many varieties of implementation requirement in a rather easy way. The behavior of FE2.1 can be configured by either board design selected options or through contents of external EEPROM.

### LED Indicators, Number of Downstream Facing Port, and Non-Removable Devices

According to USB 2.0 Specification, the status of each downstream port is shown by two LED indicators – the Green and Amber LED. FE2.1 supports the full function as specified by DRV and LED[7:1] pins. Figure 4 shows how these port status indicators be connected, together with the external EEPROM and the *Hub Active Indicator* (the Red LED).

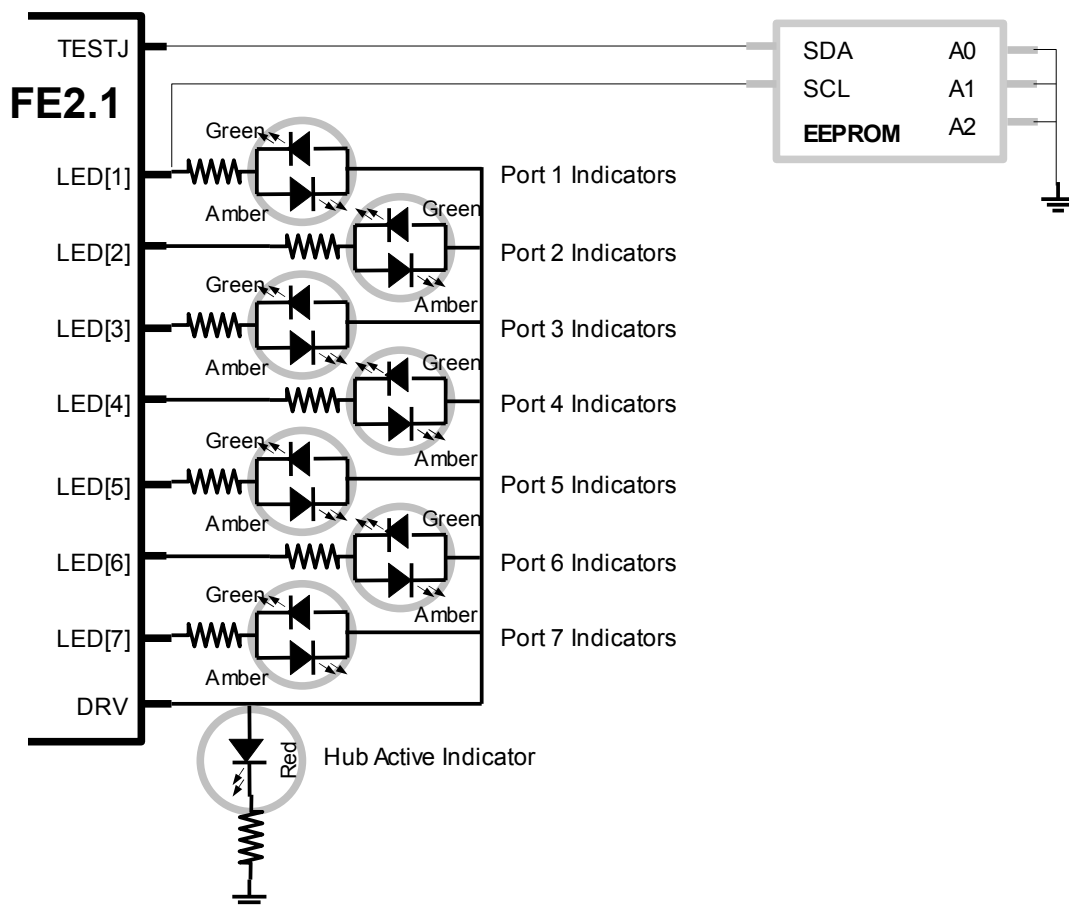


Fig. 4: LED and EEPROM Connections

The optional Hub Active Indicator is only turned on when the hub is configured by the host, and turned off when the hub is either set into suspend mode, disconnected, or powered off by the host. Any of these fifteen LED's could be removed without effecting the normal function of the hub.



The LED[7:1] pins could also be used to configure the number of downstream facing port and non-removable downstream devices. These option selections are sampled and loaded each time after chip reset. If an alternate configuration is intended, the corresponding pins should be tied to ground as shown in the following table. Otherwise, denoted as **Normal** in the following tables, they could be either left floating or connected to the LED's as shown by figure 4.

| Usable Downstream Facing Port | LED[7]         | LED[6]         |
|-------------------------------|----------------|----------------|
| 4, 3, 2, 1                    | Tied-to-Ground | Tied-to-Ground |
| 5, 4, 3, 2, 1                 | Normal         | Tied-to-Ground |
| 6, 5, 4, 3, 2, 1              | Tied-to-Ground | Normal         |
| 7, 6, 5, 4, 3, 2, 1           | Normal         | Normal         |

Setting the number of Downstream Facing Port by tying any of LED[7:6] to ground will change the **bNbrPorts** field (3<sup>rd</sup> byte) of *Hub Descriptor* as response to host's **GetHubDescriptor** request. Henceforth the ports beyond the specified number will not be recognized nor activated by the host.

| Non-Removable Downstream Facing Ports | LED[4]         | LED[3]         | LED[2]         |
|---------------------------------------|----------------|----------------|----------------|
| None                                  | Normal         | Normal         | Normal         |
| 2                                     | Normal         | Normal         | Tied-to-Ground |
| 3, 2                                  | Normal         | Tied-to-Ground | Normal         |
| 3, 2, 1                               | Normal         | Tied-to-Ground | Tied-to-Ground |
| 4, 3, 2, 1                            | Tied-to-Ground | Normal         | Normal         |
| 5, 4, 3, 2, 1                         | Tied-to-Ground | Normal         | Tied-to-Ground |
| 6, 5, 4, 3, 2, 1                      | Tied-to-Ground | Tied-to-Ground | Normal         |
| 7, 6, 5, 4, 3, 2, 1                   | Tied-to-Ground | Tied-to-Ground | Tied-to-Ground |

The Non-Removable Downstream Facing Ports setting is reported in the bit-map of **DeviceRemovable** field of Hub Class Descriptor.

When a downstream facing port is configured as unusable or non-removable, its corresponding LED pin will be disabled. In other words, those LED pins should be either tied to ground based on the selected configuration, or left floating. The only exception is LED[1], which would be still used as SCL, Serial Clock pin for external EEPROM, should it exist.



Figure 5 depicts an example that enable 5 downstream facing ports only, with port 3 and 2 as non-removable device. As shown, the LED[4] is connected to the LED's, LED[2] left floating, and LED[3] tied to ground, so that the FE2.1 would recognize that port 3 and 2 are non-removable devices. The LED[6] is tied to ground and LED[7] left floating, thus the FE2.1 will report to system that only 5 ports are available in this hub.

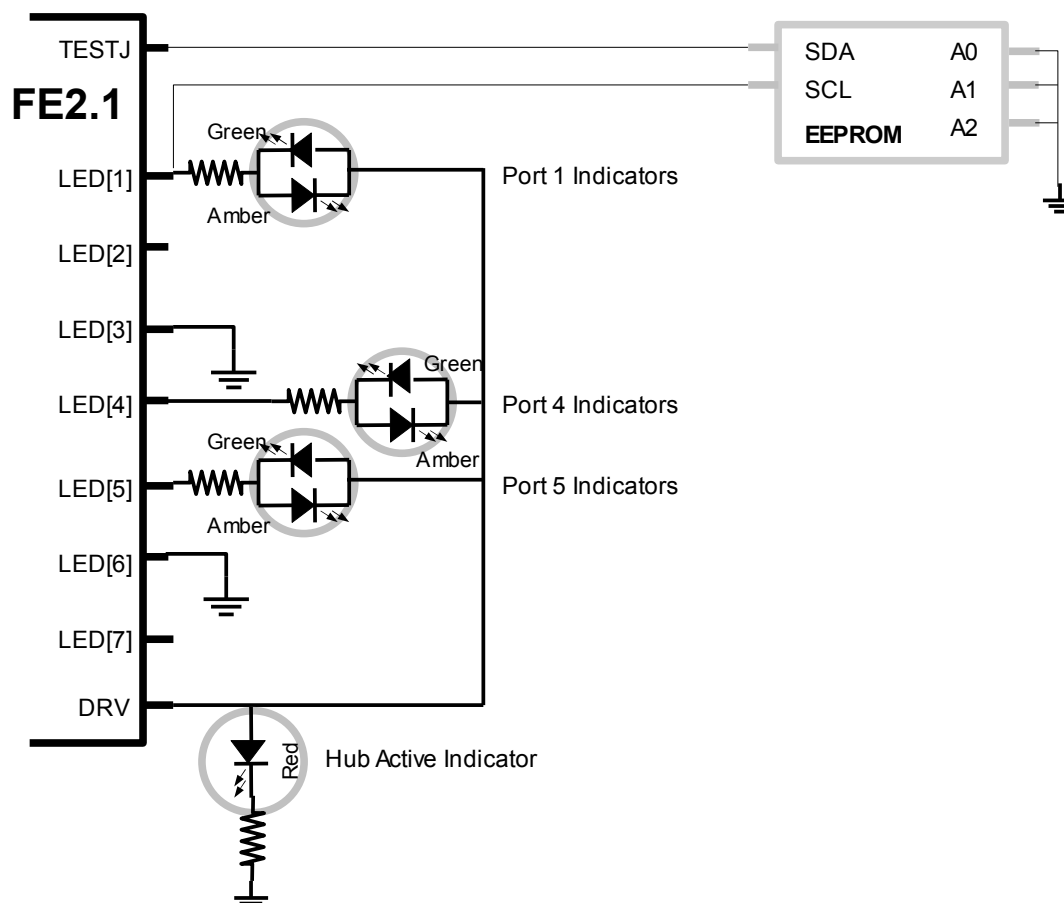


Fig. 5: LED Board Configuration Example

If the external EEPROM is not required, the TESTJ should be left floating. If the Hub Active Indicator is not required, the LED and its serial resistor should be removed together. If the port status LED's are not required, LED[5:4, 1] could be all left floating with all their related Green/Amber LED's and resistors removed.



## Power Control and Over-current Protection

The FE2.1 supports optional power switches that control delivery of power downstream facing ports by way of a set of active low, open drain, control pins, PWRJ[7:1]. With external pull-up resistors to either 5V or 3.3V, system designers could choice from a wide variety of circuit to implement the power switches.

As self-powered hub, over-current protection is a must for safety reasons. The FE2.1 provides a set of input pins, OVCJ[7:1], to monitor status of external over-current detection circuit. The over-current status will than be reported to the host hub driver by FE2.1. Depends on the power control mode actually selected, the unused OVCJ pins will be internally pull-up and left unconnected on board.

The FE2.1 supports three types of power control modes, namely *Individual Mode*, *Multiple Gangs Mode*, and *Ganged Mode*. These modes could be configured by tying either or both of PWRJ[7:6] to ground according to the following table.

| Power Control Mode  | PWRJ[7]        | PWRJ[6]        | wHubCharacteristics |        | PWRJ [N]            | OVCJ [N]            | Availability     |
|---------------------|----------------|----------------|---------------------|--------|---------------------|---------------------|------------------|
|                     |                |                | D1..D0              | D4..D3 |                     |                     |                  |
| Individual Mode     | Normal         | Normal         | 01                  | 01     | 1, 2, 3, 4, 5, 6, 7 | 1, 2, 3, 4, 5, 6, 7 | LQFP-64          |
| Multiple Gangs Mode | Tied-to-Ground | Normal         | 00                  | 01     | 1                   | 1, 5                | LQFP-64, LQFP-48 |
| Ganged Mode         | Tied-to-Ground | Tied-to-Ground | 00                  | 00     | 1                   | 1                   | LQFP-64          |

In the *Individual Mode*, the power switch of each port is controlled individually, and the over-current status is reported on a per-port basis. That is, for each port  $N$ , the power switch is controlled by PWRJ[N], and the over-current status is monitored by OVCJ[N].

In the *Ganged Mode*, the power switch to all ports are controlled by one single PWRJ[1], and the over-current is monitored by OVCJ[1]. Therefore, when host issues SetPortFeature(PORT\_POWER) to any of the downstream facing port, the PWRJ[1] will go active, and only when all ports are in powered-off state that PWRJ[1] will be turned inactive. Since there is only one OVCJ input, all downstream facing ports will be marked as over-current simultaneously and set to powered-off state.

The *Multiple Gangs Mode* has one more over-current status pin, OVCJ[5], then the Ganged Mode. If



OVCJ[1] goes low, downstream facing port 1, 2, 3, and 4 would be marked as over-current. If OVCJ[5] goes low, downstream facing port 5, 6, and 7 would be marked as over-current. Since there is only one PWRJ pin, all ports will be switched to powered-off state at once. This is the only mode supported by LQFP-48 package of FE2.1.

The power control mode selection is reported to the host software through the `wHubCharacteristics` field, the 4<sup>th</sup> and 5<sup>th</sup> byte, of `Hub Descriptor`, which describes the hub's operational characteristics. Two bit-fields would be effected – “D1..D0” for *Logical Power Switching Mode*, and “D4..D3” for *Over-current Protection Mode*. In “D1..D0”, 00 means ganged power switching (all ports' power at the once,) and 01 means individual port power switching. In “D4..D3”, 00 represents global over-current protection, and 01 represents individual port over-current protection.

Figure 6 demonstrates a LQFP-64 implementation of Individual Mode design with dual-channel power distribution switches. In this case, 3,3V pull-up are used for PWRJ/Enable pins to meet the requirement of the specific switches used.

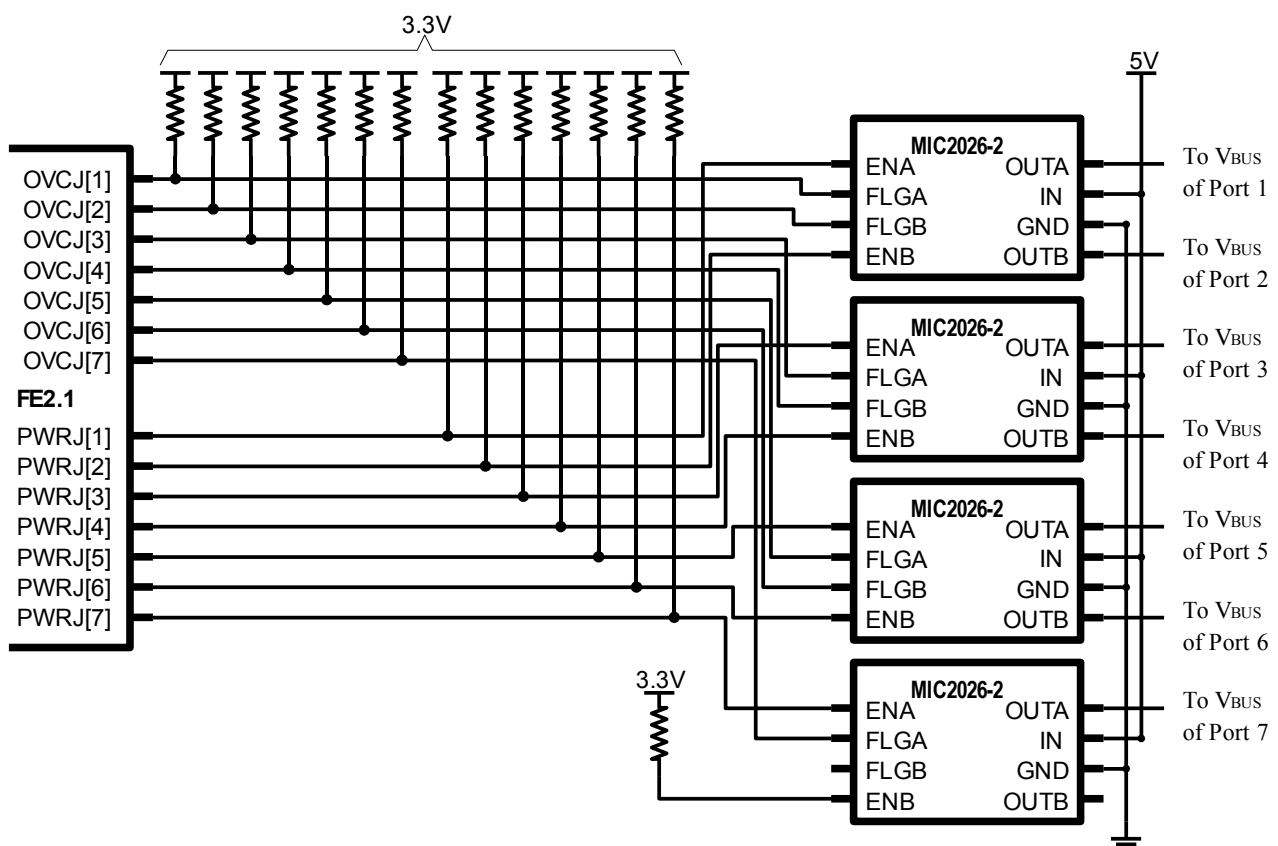


Fig. 6: LQFP-64 Individual Power Control Mode Example

Figure 7 demonstrates LQFP-64 implementations of Multiple Gangs Mode and Ganged Mode with



polymeric PTC and MOSFET switches. In these cases, 5V pull-up are used instead.

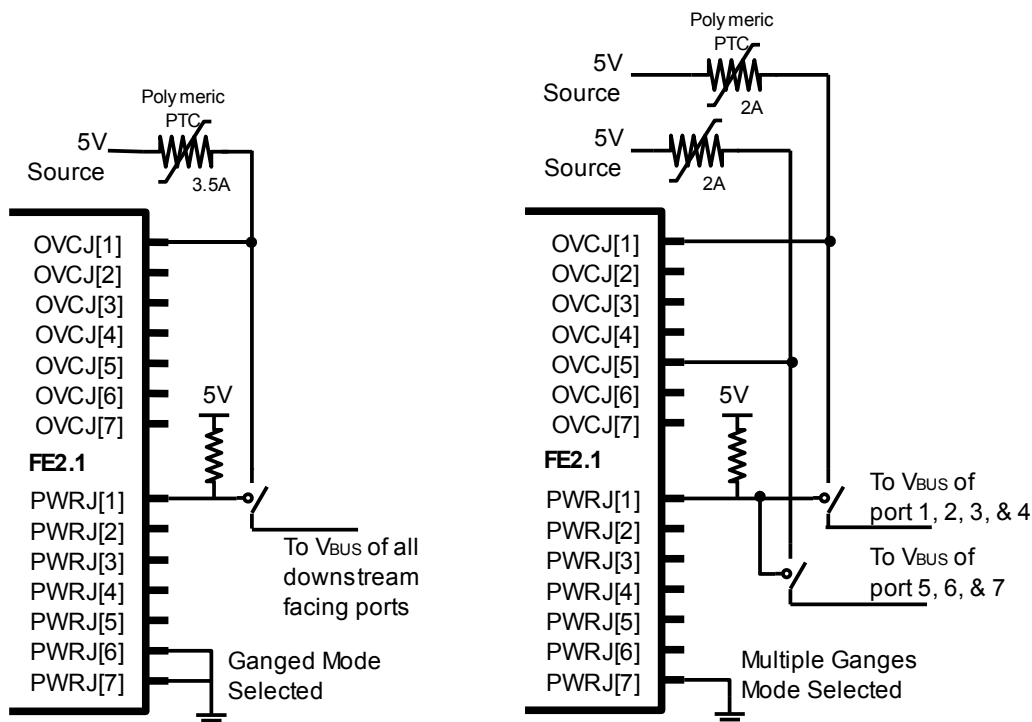


Fig. 7: LQFP-64 Power Control Mode Examples

And Figure 8 shows LQFP-48 implementation for Multiple Gangs Mode – the only mode supported by LQFP-48 package.

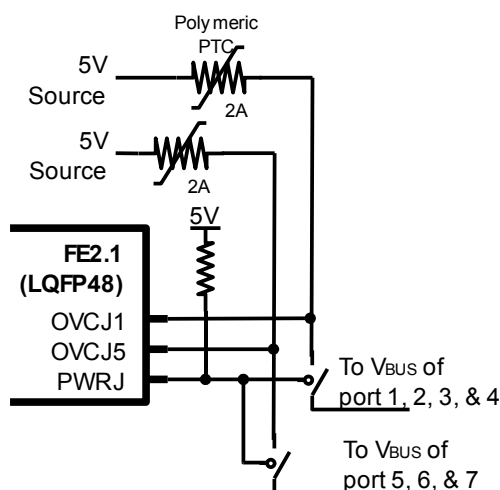


Fig. 8: LQFP-48 Power Control Example



## EEPROM CONTENTS

| Address     | Contents                | Note  |
|-------------|-------------------------|---|
| 0x00        | 0x40                    | Constant, low byte of check code  |
| 0x01        | 0x1A                    | Constant, high byte of check code   |
| 0x02        | Vendor ID (Low)         | Low byte of Vendor ID, idVendor field of <i>Standard Device Descriptor</i>  |
| 0x03        | Vendor ID (High)        | High byte of Vendor ID, idVendor field of <i>Standard Device Descriptor</i>   |
| 0x04        | Product ID (Low)        | Low byte of Product ID, idProduct field of <i>Standard Device Descriptor</i>  |
| 0x05        | Product ID (High)       | High Byte of Product ID, idProduct field of <i>Standard Device Descriptor</i>   |
| 0x06        | Device Release (Low)    | Low byte of Device Release Number, must be Binary Coded Decimal, bcdDevice field of <i>Standard Device Descriptor</i>   |
| 0x07        | Device Release (High)   | High byte of Device Release Number, must be Binary Coded Decimal, bcdDevice field of <i>Standard Device Descriptor</i>  |
| 0x08 ~ 0x17 | Device Serial Number    | Device's Serial Number – the contents of string descriptor describing the device's serial number.   |
| 0x18        | Length of Serial Number | Length of effective “Device Serial Number” stored in 0x08 to 0x17.  |
| 0x19        | Filling                 | 0x00  |
| 0x1A        | Port Number             | Number of Downstream Ports, bNbrPorts field of <i>Hub Descriptor</i> .  |
| 0x1B        | Filling                 | 0x00  |
| 0x1C        | Device Removable        | <i>DeviceRemovable</i> field of Hub Descriptor – Indicates if a port has a removable device attached. If bit <i>N</i> is set to 1, then the device on downstream facing port <i>N</i> is non-removable. Otherwise, it is removable. Bit 0 is reserved and should be 0.  |
| 0x1D        | Filling                 | 0x00  |
| 0x1E        | Device Attributes       | Bit 0: Port Indicators Support, bit 7 of <i>wHubCharacteristics</i> field of Hub Descriptor –<br>0: Port Indicators are not supported on its downstream facing ports and PORT_INDICATOR request has no effect.<br>1: Port Indicators are supported on its downstream facing ports and PORT_INDICATOR request controls the indicators.<br>Bit 1: Identifies a Compound Device, bit 2 of <i>wHubCharacteristics</i> field of Hub Descriptor –<br>0: Hub is not part of a compound device.<br>1: Hub is part of a compound device.<br>Bit 2: Maximum current requirements of the Hub Controller electronics, <i>bHubContrCurrent</i> field of Hub Descriptor –<br>0: 200mA.<br>1: 500mA.<br>Bit 3 to 7, reserved, must be 0's. |
| 0x1F        | Check Sum               | The 8-bit sum of all value from 0x00 to 0x1E.   |



The first two bytes are the check code for the existence of EEPROM, their value must be 0x1A40. Any other value would cause the EEPROM loading mechanism of FE2.1 to conclude that the contents of this EEPROM is unusable, and use default values instead.

The string descriptor for device's serial number could be defined by *Device Serial Number* and *Length of Serial Number* fields of the EEPROM, address 0x08 to 0x18. Length of Serial Number field, address 0x18, define the number of digits, while Device Serial Number field, address 0x08 to 0x17, specify the serial number in ASCII code. The space after the specified number of digits should be filled with Null, 0x00. For example, suppose the serial number is "A090108F4", then the EEPROM should be like:

|      |          |             |             |             |             |             |             |             |
|------|----------|-------------|-------------|-------------|-------------|-------------|-------------|-------------|
| 0x08 | 0x41 (A) | 0x30 (0)    | 0x39 (9)    | 0x30 (0)    | 0x31 (1)    | 0x30 (0)    | 0x38 (8)    | 0x46 (F)    |
| 0x10 | 0x34 (4) | 0x00 (Null) | 0x00 (Null) | 0x00 (Null) | 0x00 (Null) | 0x00 (Null) | 0x00 (Null) | 0x00 (Null) |
| 0x18 | 0x09     |             |             |             |             |             |             |             |

The last byte, address 0x1F, is a checksum made up of the sum of all value from 0x00 to 0x1E. The numbers must match to render the contents of the EEPROM usable. Otherwise, the loading mechanism of FE2.1 would discard the value from EEPROM and use default values instead.





## ELECTRICAL CHARACTERISTICS

### ***ABSOLUTE MAXIMUM RATINGS***

| Parameter            | Symbol                        | Min.                 | Max.                 | Unit |
|----------------------|-------------------------------|----------------------|----------------------|------|
| Storage Temperature  | TS                            | -55                  | +150                 | °C   |
| Power Supply Voltage | VDD5<br>VD33<br>VD18 & VD_PLL | -0.5<br>-0.5<br>-0.5 | +6.0<br>+4.0<br>+2.5 | V    |
| ESD Human Body Mode  |                               | -2000                | 2000                 | V    |
| ESD Machine Mode     |                               | -200                 | 200                  | V    |
| Latch Up             |                               | -200                 | 200                  | mA   |

### ***RECOMMENDED OPERATING RANGES***

| Parameter                                  | Symbol                        | Min.               | Typ.              | Max.               | Unit |
|--|-------------------------------|--------------------|-------------------|--------------------|------|
| Operating temperature                      | TA                            | 0                  |                   | 70                 | °C   |
| Operating voltage                          | VDD5<br>VD33<br>VD18 & VD_PLL | 4.5<br>3.0<br>1.62 | 5.0<br>3.3<br>1.8 | 5.5<br>3.6<br>1.98 | V    |
| LOW level voltage of digital input         | VIL                           | -0.3               |                   | 0.8                | V    |
| HIGH level voltage of digital input        | VIH                           | 2.0                |                   | 5.5                | V    |
| Threshold voltage of digital input         | VTH                           | 1.45               | 1.58              | 1.74               | V    |
| Low-to-High level of schmitt-trigger input | VT+                           | 1.44               | 1.5               | 1.56               | V    |
| High-to-Low level of schmitt-trigger input | VT-                           | 0.89               | 0.94              | 0.99               | V    |
| LOW level voltage of digital output@4mA    | VOL                           |                    |                   | 0.4                | V    |
| HIGH level voltage of digital output@4mA   | VOH                           | 2.4                |                   |                    | V    |
| Internal Pull-Up Resister Range            | R <sub>PU</sub>               | 39                 | 65                | 116                | KΩ   |



## POWER CONSUMPTION

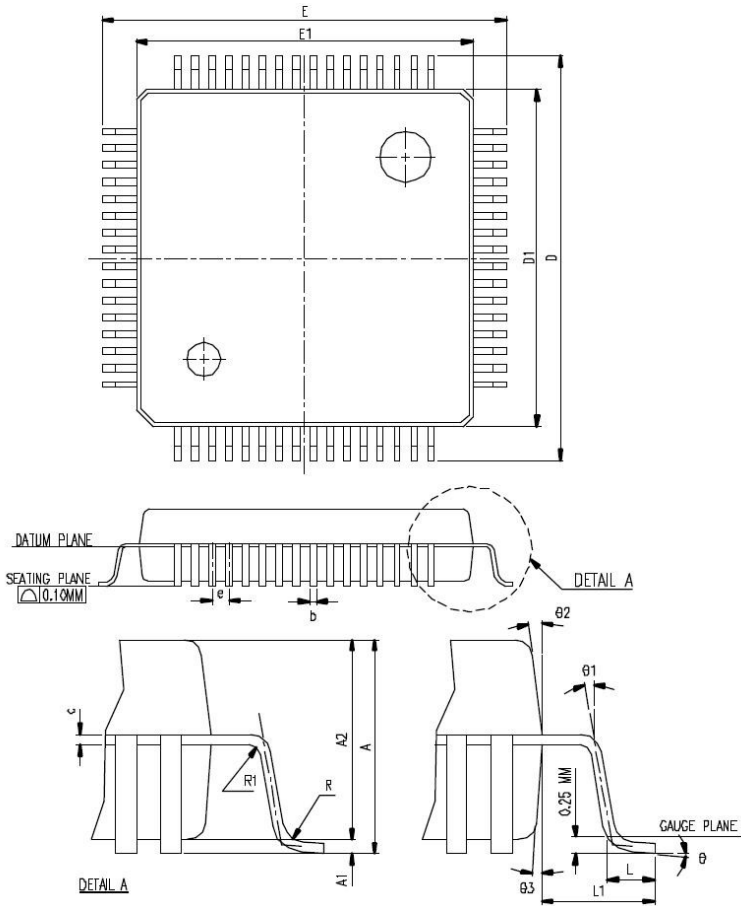
### DC SUPPLY CURRENT

| Symbol          | Condition    |            |               | Typ. | Unit |
|-----------------|--------------|------------|---------------|------|------|
|                 | Active ports | Host       | Device        |      |      |
| I_suspend       | Suspend      |            |               | 600  | uA   |
| I <sub>cc</sub> | 7            | Full-Speed | 7x Full-Speed | 36   | mA   |
|                 |              | High-Speed | 7x High-Speed | 155  | mA   |
|                 |              | High-Speed | 7x Full-Speed | 53   | mA   |
|                 | 6            | Full-Speed | 6x Full-Speed | 36   | mA   |
|                 |              | High-Speed | 6x High-Speed | 140  | mA   |
|                 |              | High-Speed | 6x Full-Speed | 53   | mA   |
|                 | 5            | Full-Speed | 5x Full-Speed | 36   | mA   |
|                 |              | High-Speed | 5x High-Speed | 125  | mA   |
|                 |              | High-Speed | 5x Full-Speed | 53   | mA   |
|                 | 4            | Full-Speed | 4x Full-Speed | 35   | mA   |
|                 |              | High-Speed | 4x High-Speed | 111  | mA   |
|                 |              | High-Speed | 4x Full-Speed | 52   | mA   |
|                 | 3            | Full-Speed | 3x Full-Speed | 35   | mA   |
|                 |              | High-Speed | 3x High-Speed | 96   | mA   |
|                 |              | High-Speed | 3x Full-Speed | 52   | mA   |
|                 | 2            | Full-Speed | 2x Full-Speed | 35   | mA   |
|                 |              | High-Speed | 2x High-Speed | 82   | mA   |
|                 |              | High-Speed | 2x Full-Speed | 52   | mA   |
|                 | 1            | Full-Speed | 1x Full-Speed | 35   | mA   |
|                 |              | High-Speed | 1x High-Speed | 66   | mA   |
|                 |              | High-Speed | 1x Full-Speed | 52   | mA   |
|                 | No active    | Full-Speed |               | 35   | mA   |
|                 |              | High-Speed |               | 52   | mA   |



PACKAGE I

64-pin LQFP (Body Size: 10x10 mm)



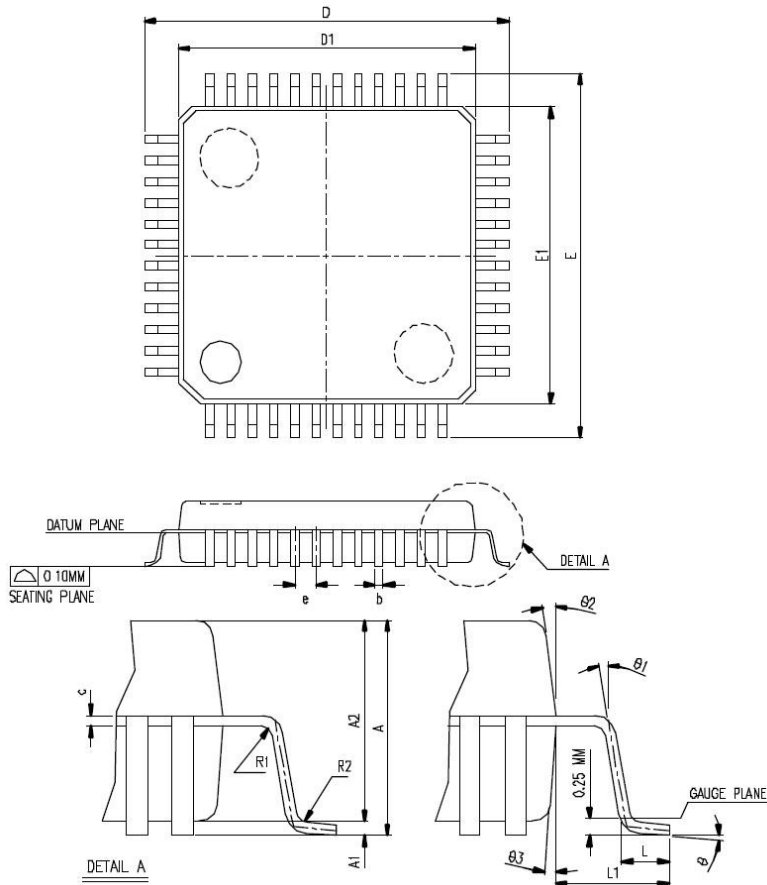
| SYMBOL | DIMENSION IN MM |      |      | DIMENSION IN INCH |       |       |
|--------|-----------------|------|------|-------------------|-------|-------|
|        | MIN.            | NOM. | MAX. | MIN.              | NOM.  | MAX.  |
| A      |                 |      | 1.60 |                   |       | 0.063 |
| A1     | 0.05            |      | 0.15 | 0.002             |       | 0.006 |
| A2     | 1.35            | 1.40 | 1.45 | 0.053             | 0.055 | 0.057 |
| b      | 0.17            | 0.20 | 0.23 | 0.007             | 0.008 | 0.009 |
| c      | 0.09            |      | 0.16 | 0.004             |       | 0.006 |
| e      | 0.50 BASIC      |      |      | 0.020 BASIC       |       |       |
| D      | 12.00 BASIC     |      |      | 0.472 BASIC       |       |       |
| D1     | 10.00 BASIC     |      |      | 0.394 BASIC       |       |       |
| E      | 12.00 BASIC     |      |      | 0.472 BASIC       |       |       |
| E1     | 10.00 BASIC     |      |      | 0.394 BASIC       |       |       |
| L      | 0.45            | 0.60 | 0.75 | 0.018             | 0.024 | 0.030 |
| L1     | 1.00 REF.       |      |      | 0.039 REF.        |       |       |
| R1     | 0.08            |      |      | 0.003             |       |       |
| R      | 0.08            |      | 0.20 | 0.003             |       | 0.008 |
| θ      | 0               | 3.5  | 7    | 0                 | 3.5   | 7     |
| θ1     | 0               |      |      | 0                 |       |       |
| θ2     | 11              | 12   | 13   | 11                | 12    | 13    |
| θ3     | 11              | 12   | 13   | 11                | 12    | 13    |
| JEDEC  | MS-026 (BCD)    |      |      |                   |       |       |

⚠️ NOTES : DIMENSIONS " D1 " AND " E1 " DO NOT INCLUDE MOLD PROTRUSION. ALLOWABLE PROTRUSION IS 0.25 mm PER SIDE.  
" D1 " AND " E1 " ARE MAXIMUM PLASTIC BODY SIZE DIMENSIONS INCLUDING MOLD MISMATCH.



PACKAGE II

48-pin LQFP (Body Size: 7x7 mm)



| SYMBOL | DIMENSION IN MM |      |      | DIMENSION IN INCH |       |       |
|--------|-----------------|------|------|-------------------|-------|-------|
|        | MIN.            | NOM. | MAX. | MIN.              | NOM.  | MAX.  |
| A      |                 |      | 1.60 |                   |       | 0.063 |
| A1     | 0.05            |      | 0.15 | 0.001             |       | 0.006 |
| A2     | 1.35            | 1.40 | 1.45 | 0.053             | 0.055 | 0.057 |
| b      | 0.17            | 0.22 | 0.27 | 0.007             | 0.009 | 0.011 |
| c      | 0.09            |      | 0.20 | 0.004             |       | 0.008 |
| e      | 0.50 BASIC      |      |      | 0.020 BASIC       |       |       |
| D      | 9.00 BASIC      |      |      | 0.354 BASIC       |       |       |
| D1     | 7.00 BASIC      |      |      | 0.276 BASIC       |       |       |
| E      | 9.00 BASIC      |      |      | 0.354 BASIC       |       |       |
| E1     | 7.00 BASIC      |      |      | 0.276 BASIC       |       |       |
| L      | 0.45            | 0.60 | 0.75 | 0.018             | 0.024 | 0.030 |
| L1     | 1.00 REF.       |      |      | 0.039 REF.        |       |       |
| R1     | 0.08            |      |      | 0.003             |       |       |
| R2     | 0.08            |      | 0.20 | 0.003             |       | 0.008 |
| θ      | 0°              | 3.5° | 7°   | 0°                | 3.5°  | 7°    |
| θ1     | 0°              |      |      | 0°                |       |       |
| θ2     | 11°             | 12°  | 13°  | 11°               | 12°   | 13°   |
| θ3     | 11°             | 12°  | 13°  | 11°               | 12°   | 13°   |
| JEDDEC | MS-026 (BBC)    |      |      |                   |       |       |

\*NOTES : DIMENSIONS " D1 " AND " E1 " DO NOT INCLUDE MOLD PROTRUSION. ALLOWABLE PROTRUSION IS 0.25 mm PER SIDE.  
" D1 " AND " E1 " ARE MAXIMUM PLASTIC BODY SIZE DIMENSIONS INCLUDING MOLD MISMATCH.

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